

PNP -100mA -50V Digital Transistor (Bias Resistor Built-in Transistor)

Parameter	Value
V <sub>CC</sub>	-50V
I <sub>C(MAX.)</sub>	-100mA
R <sub>1</sub>	22kΩ
R <sub>2</sub>	47kΩ

### Features

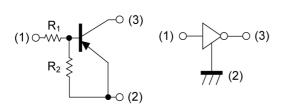
- 1) Built-In Biasing Resistors,  $R_1 = 22k\Omega$ ,  $R_2 = 47k\Omega$
- 2) Built-in bias resistors enable the configuration of an inverter circuit without connecting external input resistors (see inner circuit).
- 3) Only the on/off conditions need to be set for operation, making the circuit design easy.
- 4) Complementary NPN Types: DTC124X series

## Application

INVERTER, INTERFACE, DRIVER

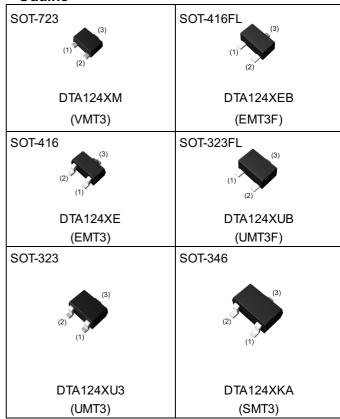
#### Inner circuit

DTA124XM/ DTA124XEB/ DTA124XUB

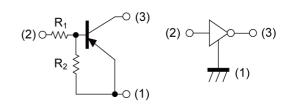


- (1) IN (BASE)
- (2) GND (+) (EMITTER)
- (3) OUT (COLLECTOR)

## Outline



## DTA124XE/ DTA124XU3/ DTA124XKA



- (1) GND (+) (EMITTER)
- (2) IN (BASE)
- (3) OUT (COLLECTOR)

## Packaging specifications

Part No.	Package	Package size	Taping code	Reel size (mm)	Tape width (mm)	Basic ordering unit.(pcs)	Marking
DTA124XM	SOT-723	1212	T2L	180	8	8000	35
DTA124XEB	SOT-416FL	1616	TL	180	8	3000	35
DTA124XE	SOT-416	1616	TL	180	8	3000	35
DTA124XUB	SOT-323FL	2021	TL	180	8	3000	35
DTA124XU3	SOT-323	2021	T106	180	8	3000	35
DTA124XKA	SOT-346	2928	T146	180	8	3000	35

## ● **Absolute maximum ratings** (T<sub>a</sub> = 25°C)

Pa	arameter	Symbol	Values	Unit	
Supply voltage			-50	V	
Input voltage		V <sub>IN</sub>	-40 to 10	V	
Output current		Io	-50	mA	
Collector current			-100	mA	
	DTA124XM		150		
	DTA124XEB		150	mW	
Davis a dia sia atia a	DTA124XE	D *2	150		
Power dissipation	DTA124XUB	P <sub>D</sub> *2	200		
	DTA124XU3		200		
	DTA124XKA		200		
Junction temperature	Junction temperature			°C	
Range of storage temperat	ure	T <sub>stg</sub>	-55 to +150	°C	

# • Electrical characteristics $(T_a = 25^{\circ}C)$

Parameter	Symbol	Conditions	Values			Unit
- Farameter	Symbol	Conditions	Min.	Тур.	Max.	Offic
lanut voltore	$V_{l(off)}$	$V_{CC} = -5V, I_{O} = -100 \mu A$	-	-	-0.4	V
Input voltage	V <sub>I(on)</sub>	$V_O = -0.3V$ , $I_O = -2mA$	-2.5	-	-	V
Output voltage	V <sub>O(on)</sub>	I <sub>O</sub> = -10mA, I <sub>I</sub> = -0.5mA	1	-100	-300	mV
Input current	l <sub>l</sub>	V <sub>I</sub> = -5V	1	-	-360	μA
Output current	I <sub>O(off)</sub>	$V_{CC} = -50V, V_{I} = 0V$	1	-	-500	nA
DC current gain	G <sub>I</sub>	$V_{O} = -5V, I_{O} = -5mA$	68	-	-	-
Input resistance	R <sub>1</sub>	-	15.4	22	28.6	kΩ
Resistance ratio	R <sub>2</sub> /R <sub>1</sub>	-	1.7	2.1	2.6	-
Transition frequency	f <sub>T</sub> *1	V <sub>CE</sub> = -10V, I <sub>E</sub> = 5mA, f = 100MHz	-	250	-	MHz

2/10

<sup>\*1</sup> Characteristics of built-in transistor

<sup>\*2</sup> Each terminal mounted on a reference land.

## ● Electrical characteristic curves (T<sub>a</sub> =25°C)

Fig.1 Input voltage vs. output current (ON characteristics)

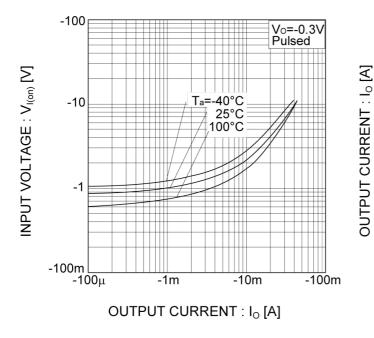


Fig.2 Output current vs. input voltage (OFF characteristics)

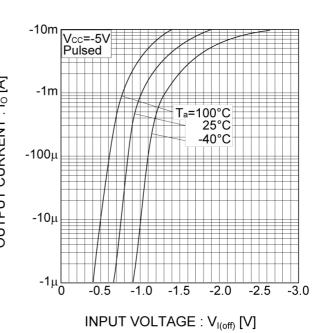


Fig.3 Output current vs. output voltage

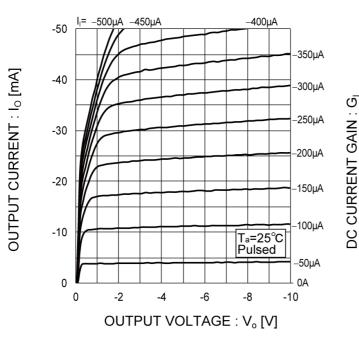
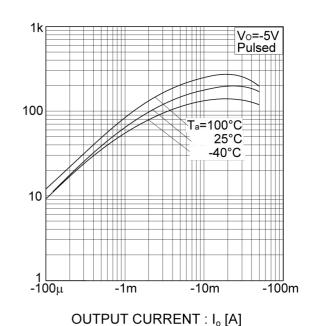
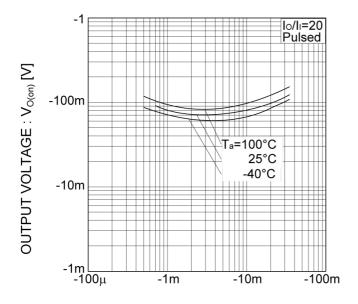


Fig.4 DC current gain vs. output current

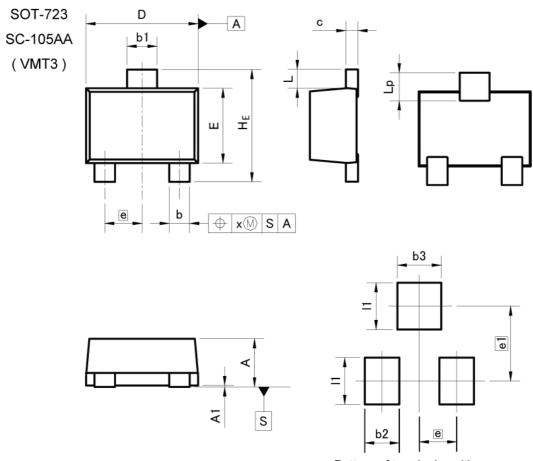


# ●Electrical characteristic curves (T<sub>a</sub> =25°C)

Fig.5 Output voltage vs. output current



OUTPUT CURRENT : Io [A]



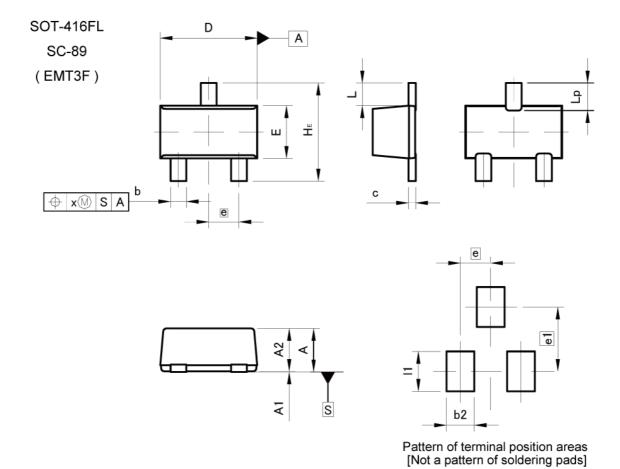
Pattern of terminal position areas [Not a pattern of soldering pads]

DIM	MILIM	ETERS	INC	HES
DIM	MIN	MAX	MIN	MAX
Α	0.45	0.55	0.018	0.022
A1	0.00	0.10	0.000	0.004
b	0.17	0.27	0.007	0.011
b1	0.27	0.37	0.011	0.015
С	0.08	0.18	0.003	0.007
D	1.10	1.30	0.043	0.051
E	0.70	0.90	0.028	0.035
е	0.4	40	0.0	02
HE	1.10	1.30	0.043	0.051
L	0.10	0.30	0.004	0.012
Lp	0.20	0.40	0.008	0.016
x	-	0.10	ı	0.004

DIM	MILIMETERS		INCHES	
DIM	MIN	MAX	MIN	MAX
b2	-	0.37	ı	0.015
b3	_	0.47	7-	0.019
e1	0.80		0.0	31
11	-	0.50	_	0.020

Dimension in mm/inches



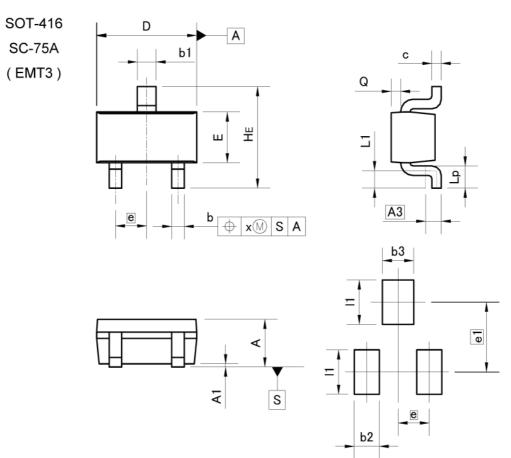


DIM	MILIM	ETERS	INC	HES
	MIN	MAX	MIN	MAX
Α	0.65	0.85	0.026	0.033
A1	0.00	0.10	0.000	0.004
A2	0.60	0.80	0.024	0.031
b	0.21	0.36	0.008	0.014
С	0.08	0.18	0.003	0.007
D	1.50	1.70	0.059	0.067
E	0.76	0.96	0.030	0.038
е	0.	50	0.0	20
HE	1.50	1.70	0.059	0.067
L	0.37		0.015	
Lp	0.35	0.55	0.014	0.022
Х	-	0.10	-	0.004

DIM	MILIMETERS		INCHES		
DIM	MIN	MAX	MIN	MAX	
b2	-	0.46	-	0.018	
e1	-	1.05	-	0.041	
11	-	0.65	-	0.026	

Dimension in mm/inches





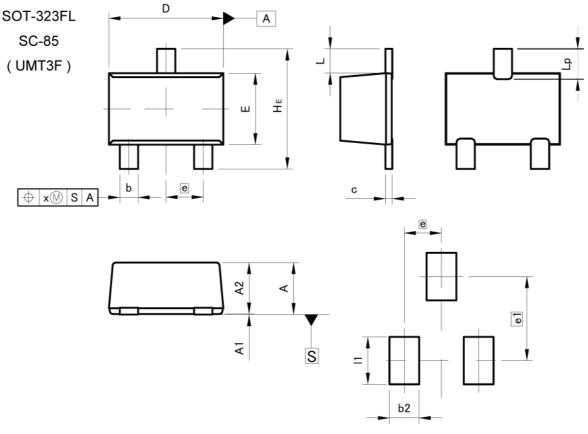
Pattern of terminal position areas [Not a pattern of soldering pads]

DIM	MILIM	ETERS	INC	HES
DIM	MIN	MAX	MIN	MAX
Α	0.60	0.80	0.024	0.031
A1	0.00	0.10	0.000	0.004
A3	0.	25	0.0	10
b	0.15	0.30	0.006	0.012
b1	0.25	0.40	0.010	0.016
С	0.10	0.20	0.004	0.008
D	1.50	1.70	0.059	0.067
E	0.70	0.90	0.028	0.035
е	0.	50	0.0	20
HE	1.40	1.80	0.055	0.071
L1	0.10	-	0.004	-
Lp	0.15		0.006	2=
Q	0.05	0.25	0.002	0.010
х	1. <del>-</del>	0.10	, <del>-</del> ,	0.004

	DIM	MILIM	ETERS	INCHES	
		MIN	MAX	MIN	MAX
	b2	1	0.40	-	0.016
	b3	I	0.50	-	0.020
	e1	1.10		0.0	43
	l1		0.70		0.028

Dimension in mm/inches





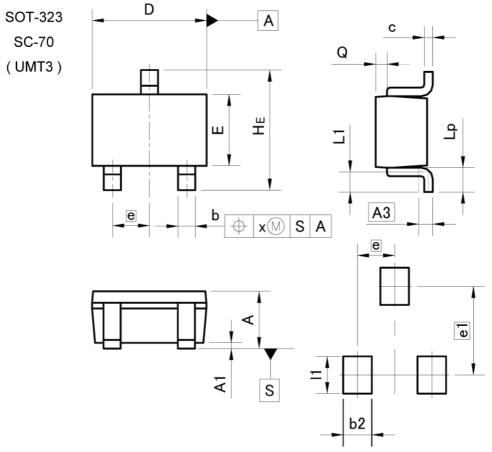
Pattern of terminal position areas [Not a pattern of soldering pads]

DIM	MILIM	ETERS	INC	HES	
DIM	MIN	MAX	MIN	MAX	
Α	0.85	1.05	0.033	0.041	
A1	0.00	0.10	0.000	0.004	
A2	0.80	1.00	0.031	0.039	
b	0.27	0.42	0.011	0.017	
С	0.08	0.18	0.003	0.007	
D	1.90	2.10	0.075	0.083	
E	1.15	1.35	0.045	0.053	
е	0.0	65	0.026		
HE	2.00	2.20	0.079	0.087	
L	0.425		0.0	17	
Lp	0.43	0.63	0.017	0.025	
х	_	0.10	-	0.004	

	DIM	MILIM	MILIMETERS		HES
		MIN	MAX	MIN	MAX
	b2	_	0.52	-	0.020
	e1	1.47		0.0	58
	I1	- 0.83		ı	0.033

Dimension in mm/inches





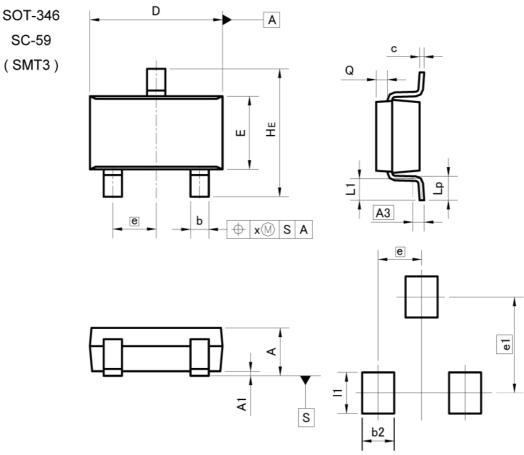
Pattern of terminal position areas [Not a pattern of soldering pads]

DIM	MILIMETERS		INCHES	
	MIN	MAX	MIN	MAX
Α	0.80	1.00	0.031	0.039
A1	0.00	0.10	0.000	0.004
A3	0.25		0.010	
b	0.25	0.40	0.010	0.016
С	0.10	0.20	0.004	0.008
D	1.90	2.10	0.075	0.083
E	1.15	1.35	0.045	0.053
е	0.65		0.026	
HE	2.00	2.20	0.079	0.087
L1	0.10	0.40	0.004	0.016
Lp	0.25	0.55	0.010	0.022
Q	0.10	0.30	0.004	0.012
X	-	0.10	-	0.004

DIM	MILIMETERS		INCHES	
	MIN	MAX	MIN	MAX
b2	_	0.50	_	0.020
e1	1.55		0.061	
- 11	-	0.65	-	0.026

Dimension in mm/inches





Pattern of terminal position areas [Not a pattern of soldering pads]

DIM	MILIMETERS		INCHES	
	MIN	MAX	MIN	MAX
Α	1.00	1.30	0.039	0.051
A1	0.00	0.10	0.000	0.004
A3	0.25		0.010	
b	0.35	0.50	0.014	0.020
С	0.09	0.25	0.004	0.010
D	2.80	3.00	0.110	0.118
E	1.50	1.80	0.059	0.071
е	0.95		0.037	
HE	2.60	3.00	0.102	0.118
L1	0.30	0.60	0.012	0.024
Lp	0.40	0.70	0.016	0.028
Q	0.20	0.30	0.008	0.012
х	-	0.10	-	0.004
у	- >	0.10	(-	0.004

DIM	MILIMETERS		INCHES		
	MIN	MAX	MIN	MAX	
	b2	-	0.60	_	0.024
	e1	2.10		0.083	
	11	-3	0.90	-	0.035

Dimension in mm/inches



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JAPAN	USA	EU	CHINA
CLASSⅢ	CL ACCIII	CLASS II b	CL A C C TT
CLASSIV	CLASSII	CLASSⅢ	CLASSⅢ

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  - [e] Use of our Products in proximity to heat-producing components, plastic cords, or other flammable items
  - [f] Sealing or coating our Products with resin or other coating materials
  - [g] Use of our Products without cleaning residue of flux (even if you use no-clean type fluxes, cleaning residue of flux is recommended); or Washing our Products by using water or water-soluble cleaning agents for cleaning residue after soldering
  - [h] Use of the Products in places subject to dew condensation
- 4. The Products are not subject to radiation-proof design.
- 5. Please verify and confirm characteristics of the final or mounted products in using the Products.
- 6. In particular, if a transient load (a large amount of load applied in a short period of time, such as pulse. is applied, confirmation of performance characteristics after on-board mounting is strongly recommended. Avoid applying power exceeding normal rated power; exceeding the power rating under steady-state loading condition may negatively affect product performance and reliability.
- 7. De-rate Power Dissipation depending on ambient temperature. When used in sealed area, confirm that it is the use in the range that does not exceed the maximum junction temperature.
- 8. Confirm that operation temperature is within the specified range described in the product specification.
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#### Precaution for Mounting / Circuit board design

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For details, please refer to ROHM Mounting specification

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This Product is electrostatic sensitive product, which may be damaged due to electrostatic discharge. Please take proper caution in your manufacturing process and storage so that voltage exceeding the Products maximum rating will not be applied to Products. Please take special care under dry condition (e.g. Grounding of human body / equipment / solder iron, isolation from charged objects, setting of lonizer, friction prevention and temperature / humidity control).

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- 1. Product performance and soldered connections may deteriorate if the Products are stored in the places where:
  - [a] the Products are exposed to sea winds or corrosive gases, including Cl2, H2S, NH3, SO2, and NO2
  - [b] the temperature or humidity exceeds those recommended by ROHM
  - [c] the Products are exposed to direct sunshine or condensation
  - [d] the Products are exposed to high Electrostatic
- Even under ROHM recommended storage condition, solderability of products out of recommended storage time period
  may be degraded. It is strongly recommended to confirm solderability before using Products of which storage time is
  exceeding the recommended storage time period.
- 3. Store / transport cartons in the correct direction, which is indicated on a carton with a symbol. Otherwise bent leads may occur due to excessive stress applied when dropping of a carton.
- 4. Use Products within the specified time after opening a humidity barrier bag. Baking is required before using Products of which storage time is exceeding the recommended storage time period.

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